

Surface Mount Fast Recovery Rectifiers

FEATURES:

- For surface mounted applications
- · Low profile package
- Glass Passivated Chip Junction
- Easy to pick and place
- Fast reverse recovery time
- Lead free in comply with EU RoHS 2011/65/EU directives

Circuit Diagram & Pin Configuration:





Marking

Marking code			
F2			
1 F2			
F5			
F7			
F7			

SOD-123FL

Absolute Maximum Ratings and Characteristics

Ratings at 25 °C ambient temperature unless otherwise specified. Single phase, half wave, 60 Hz, resistive or inductive load. For capacitive load, derate current by 20%.

Parameter	Symbols	FR101W	FR102W	FR103W	FR104W	FR105W	FR106W	FR107W	Units
Maximum Repetitive Peak Reverse Voltage	V_{RRM}	50	100	200	400	600	800	1000	V
Maximum RMS voltage	V_{RMS}	35	70	140	280	420	560	700	V
Maximum DC Blocking Voltage	V _{DC}	50	100	200	400	600	800	1000	V
Maximum Average Forward Rectified Current at T_c = 125 $^{\circ}$ C	I _{F(AV)}	1						А	
Peak Forward Surge Current 8.3 ms Single Half Sine Wave Superimposed on Rated Load	I _{FSM}	30						А	
Maximum Forward Voltage at 1 A	V _F	1.3						V	
Maximum DC Reverse Current $T_a = 25 ^{\circ}\text{C}$ at Rated DC Blocking Voltage $T_a = 125 ^{\circ}\text{C}$	I _R	5 100						μA	
Typical Junction Capacitance at V _R =4V, f=1MHz	Cj	15						pF	
Maximum Reverse Recovery Time (1)	t _{rr}	150 250 500				00	ns		
Typical Thermal Resistance (2)	R _{θJA}	85						°C/W	
Operating and Storage Temperature Range	T _j , T _{stg}	-55 ~ +150						°C	

^(1) Measured with $I_{\scriptscriptstyle F}$ = 0.5 A, $I_{\scriptscriptstyle R}$ = 1 A, $I_{\scriptscriptstyle rr}$ = 0.25 A.

⁽ 2) P.C.B. mounted with 2.0" X 2.0" (5 X 5 cm) copper pad areas.



Fig.1 Forward Current Derating Curve

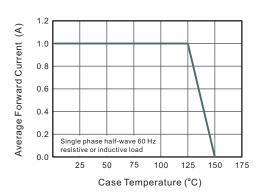


Fig.2 Typical Reverse Characteristics

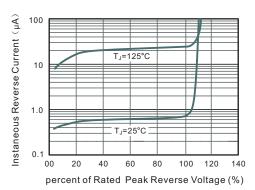


Fig.3 Typical Instaneous Forward Characteristics

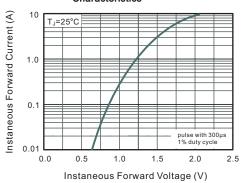


Fig.4 Typical Junction Capacitance

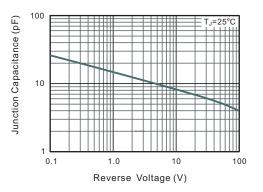
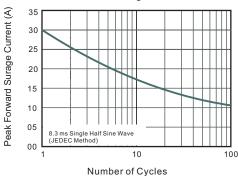


Fig.5 Maximum Non-Repetitive Peak Forward Surage Current



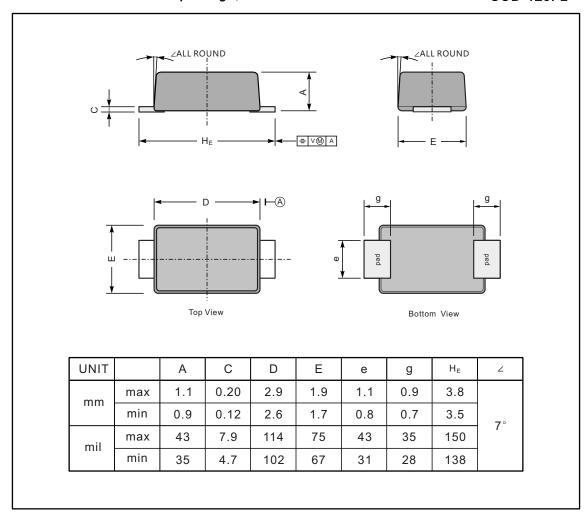
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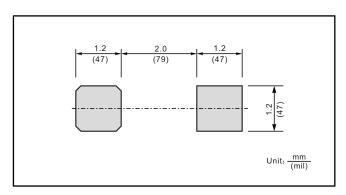
PACKAGE OUTLINE

Plastic surface mounted package; 2 leads

SOD-123FL



The recommended mounting pad size





NOTICE

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